

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China











P-channel 30 V, 0.048 Ω typ., 5 A STripFET™ H6 DeepGATE™ Power MOSFET in an SO-8 package

Datasheet - preliminary data

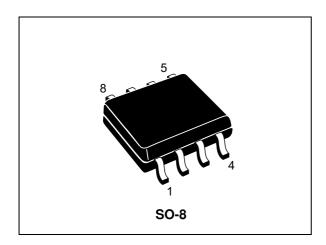
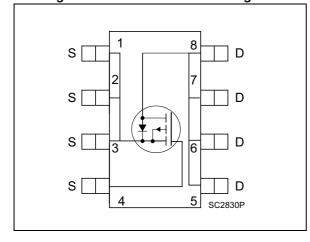


Figure 1. Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max	I _D
STS5P3LLH6	30 V	0.056 Ω at 10 V	5 A

- Very low on-resistance R_{DS(on)}
- · Very low gate charge
- · High avalanche ruggedness
- Low gate drive power loss

Applications

· Switching applications

Description

This device is a P-channel Power MOSFET developed using the STripFETTM H6 technology with a new trench gate structure. The resulting Power MOSFET exhibits very low $R_{DS(on)}$ in all packages.

Table 1. Device summary

Order code	Marking	Package	Packaging
STS5P3LLH6	5K3L	SO-8	Tape and reel

Note: For the P-channel MOSFET actual polarity of voltages and current has to be reversed.

December 2014 DocID024614 Rev 2 1/15

Contents STS5P3LLH6

Contents

1	Electrical ratings	3
2	Electrical characteristics	
3	Test circuits	8
4	Package mechanical data	9
5	Packaging mechanical data	2
6	Revision history	4

STS5P3LLH6 Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage	30	٧
V _{GS}	Gate-source voltage	± 20	V
I _D	Drain current (continuous) at T _{amb} = 25 °C	5	Α
I _D	Drain current (continuous) at T _{amb} = 100 °C	3.2	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	20	Α
P _{TOT}	Total dissipation at T _{amb} = 25 °C	2.7	W
TJ	Operating junction temperature	150	°C
T _{stg}	Storage temperature	-55 to 150	°C

^{1.} Pulse width limited by safe operating area

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thj-amb} (1)	Thermal resistance junction-amb	47	°C/W

^{1.} When mounted on 1 inch² FR-4 board, 2 oz. Cu., $t \le 10$ sec

Note:

For the P-channel Power MOSFET the actual polarity of the voltages and the current must be reversed.

Electrical characteristics STS5P3LLH6

2 Electrical characteristics

(T_{CASE} = 25 °C unless otherwise specified)

Table 4. On/off states

Symbol	Parameter	Test conditions	Min	Тур	Max	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$	30			V
	Zero gate voltage drain	$V_{GS} = 0 \text{ V}, V_{DS} = 30 \text{ V},$			1	
I _{DSS}	current	$V_{GS} = 0 \text{ V}, V_{DS} = 30 \text{ V},$ $T_{J} = 125 \text{ °C}$			10	μΑ
I _{GSS}	Gate body leakage current	$V_{DS} = 0, V_{GS} = \pm 20 \text{ V}$			100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1		2.5	V
P	Static drain-source	$V_{GS} = 10 \text{ V}, I_D = 2.5 \text{ A}$		0.048	0.056	Ω
R _{DS(on)}	on-resistance	$V_{GS} = 4.5 \text{ V}, I_D = 2.5 \text{ A}$		0.075	0.09	22

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min	Тур	Max	Unit
C _{iss}	Input capacitance		-	639	-	
C _{oss}	Output capacitance	V _{DS} = 25 V, f=1 MHz	-	79	-	pF
C _{rss}	Reverse transfer capacitance	$V_{GS} = 0$	-	52	-	r
Qg	Total gate charge	V 45.V 1 5.A	-	6	-	
Q_{gs}	Gate-source charge	$V_{DD} = 15 \text{ V}, I_{D} = 5 \text{ A}$ $V_{GS} = 4.5 \text{ V}$	-	1.9	-	nC
Q _{gd}	Gate-drain charge	145	-	2.1	-	

Table 6. Switching times

Symbol	Parameter	Test conditions	Min	Тур	Max	Unit
t _{d(on)}	Turn-on delay time		-	5.4	-	
t _r	Rise time	$V_{DD} = 15 \text{ V}, I_D = 5 \text{ A},$	-	5	-	ne
t _{d(off)}	Turn-off delay time	$R_G = 4.7 \Omega, V_{GS} = 10 V$	-	19.2	-	ns
t _f	Fall time		-	3.4	-	

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min	Тур	Max	Unit
V _{SD} ⁽¹⁾	Forward on voltage	$I_{SD} = 5 \text{ A}, V_{GS} = 0$	-		1.1	V
t _{rr}	Reverse recovery time	I _{SD} = 5 A,	-	11.2		ns
Q _{rr}	Reverse recovery charge	$di/dt = 100 A/\mu s$,	-	3.5		nC
I _{RRM}	Reverse recovery current	$V_{DD} = 16 \text{ V}, T_{J} = 150 ^{\circ}\text{C}$	-	0.6		Α

^{1.} Pulsed: pulse duration=300µs, duty cycle 1.5%

Note: For the P-channel MOSFET the actual polarity of the voltages and the current must be reversed.

Electrical characteristics STS5P3LLH6

2.1 Electrical characteristics (curves)

T=150°C T_{amb}=25°C Single pulse

10

 $V_{DS}(V)$

Figure 2. Safe operating area

I_D(A) GIPG031220141555ALS

10 100μs
1ms
1ms

Figure 3. Thermal impedance

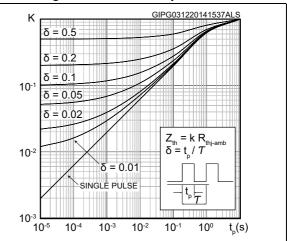
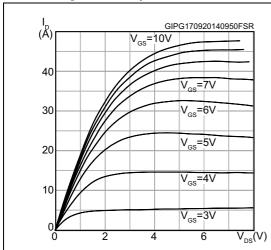


Figure 4. Output characteristics

Figure 5. Transfer characteristics



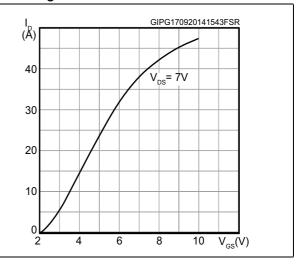
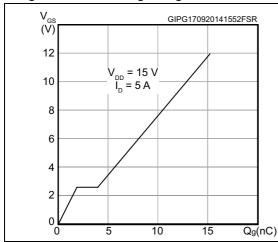


Figure 6. Gate charge vs gate-source voltage

Figure 7. Static drain-source on-resistance



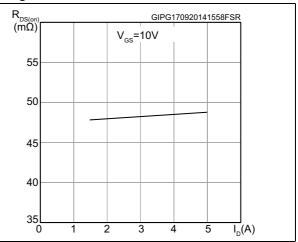


Figure 8. Normalized $V_{(BR)DSS}$ vs temperature

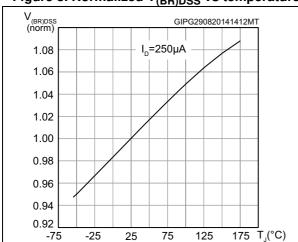


Figure 9. Capacitance variations

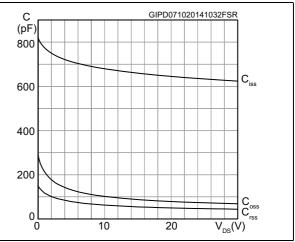
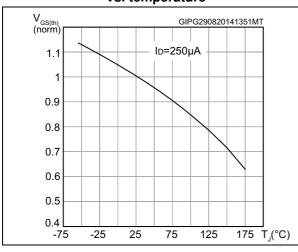


Figure 10. Normalized gate threshold voltage vs. temperature

Figure 11. Normalized on-resistance vs. temperature



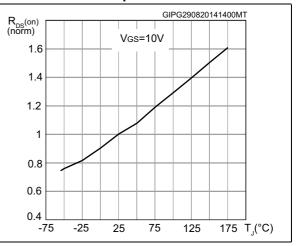
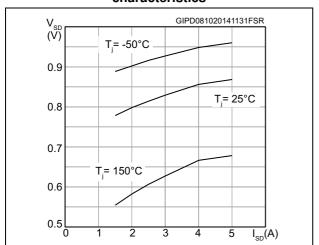


Figure 12. Source-drain diode forward characteristics



Test circuits STS5P3LLH6

3 Test circuits

Figure 13. Switching times test circuit for resistive load

Figure 14. Gate charge test circuit

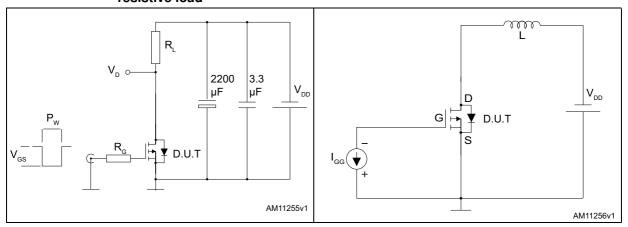
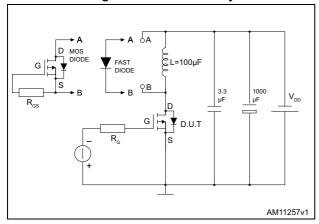


Figure 15. Test circuit for inductive load switching and diode recovery times



8/15 DocID024614 Rev 2

4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

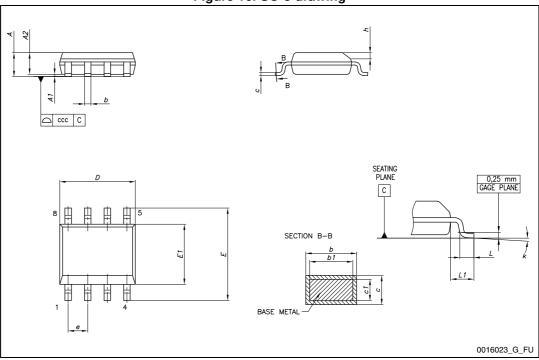


Figure 16. SO-8 drawing

Table 8. SO-8 mechanical data

		mm	
Dim.	Min.	Тур.	Max.
Α			1.75
A1	0.10		0.25
A2	1.25		
b	0.31		0.51
b1	0.28		0.48
С	0.10		0.25
c1	0.10		0.23
D	4.80	4.90	5.00
E	5.80	6.00	6.20
E1	3.80	3.90	4.00
е		1.27	
h	0.25		0.50
L	0.40		1.27
L1		1.04	
L2		0.25	
k	0°		8°
ccc			0.10

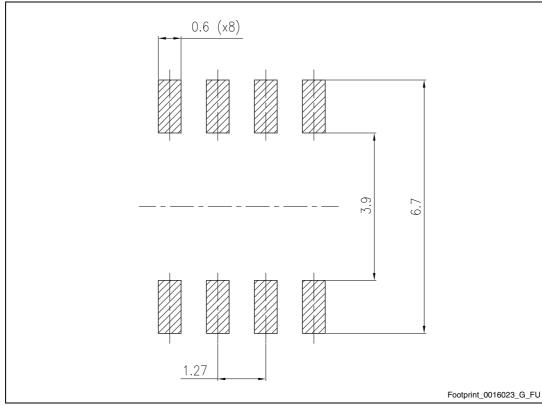


Figure 17. SO-8 recommended footprint (dimensions in mm)

5 Packaging mechanical data

Table 9. SO-8 tape and reel mechanical data

Dim		mm	
Dilli	Min	Тур	Max
Α			330
С	12.8		13.2
D	20.2		
N	60		
Т			22.4
Ao	8.1		8.5
Во	5.5		5.9
Ko	2.1		2.3
Ро	3.9		4.1
Р	7.9		8.1

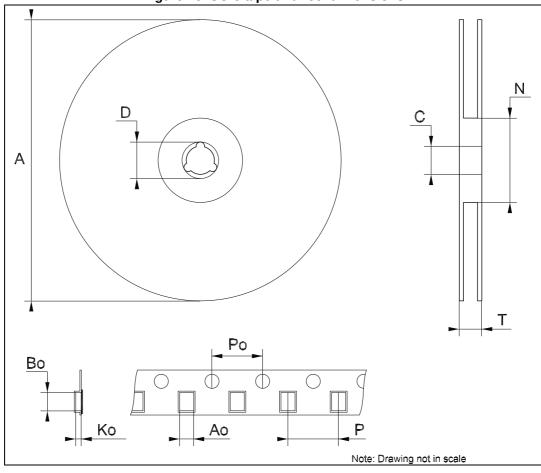


Figure 18. SO-8 tape and reel dimensions

Revision history STS5P3LLH6

6 Revision history

Table 10. Revision history

Date	Revision	Changes
09-May-2013	1	First revision.
11-Dec-2014	2	Text edits throughout document On cover page: - changed title description - updated Features - updated Description In Table 4, changed R _{DS(on)} values In Table 5, changed values and test conditions In Table 6, changed values and test conditions In Table 7, changed values and test conditions In Table 7, changed values and test conditions Added Section 2.1: Electrical characteristics (curves) Updated Section 4: Package mechanical data

IMPORTANT NOTICE - PLEASE READ CAREFULLY

STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2014 STMicroelectronics - All rights reserved

